

Revisions			
Rev	Description	Date	Approved
X1	Initial	Oct. 19, 2012	
A	Release	Oct. 26, 2012	
A1	1. DNP R2 2. DNP J1 J3, J7, J8, J9 and J10 3. DNP TE00 4. DNP BT1 5. DNP J4, J5 and populate R27, R28 6. Change R29, R30 From 10K(0603, 5%) to 510K (0603, 5%)		

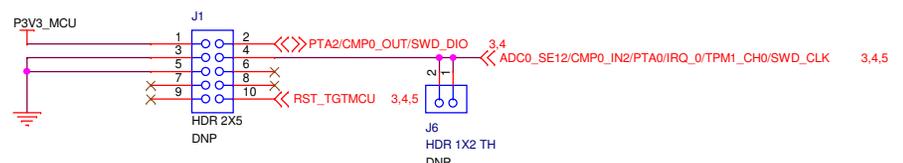
		<b>Microcontroller Solutions Group</b> 6501 William Cannon Drive West Austin, TX 78752-8689	
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Designer: Wang Peng		ICAP Classification: FOP: FLUQ: X PUB:	
Drawn by: Helen Xu		<b>FRDM-KL02Z</b>	
<b>Table of Contents/Revisions</b>			
Approved: Michael Norman	Size C	Document Number SCH-27772 PDF-SPF-27772	Rev A1
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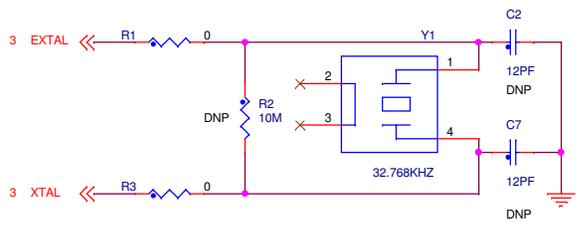
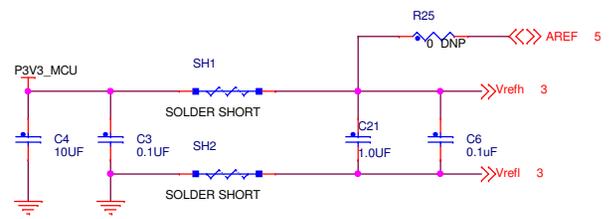
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Drawing Title: <b>FRDM-KL02Z</b>		
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### SWD CONNECTOR



There is a bottom-layer trace shorting pin 1 to pin 2 of jumper



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